

QT-Brightek Chip LED Series

SMD 0805 Green LED

Part No.: QBLP631-IG5-2897

5: 5mA

2897: High Brightness Version

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Introduction

Feature:

- Water clear lens
- Package in tap and reel
- 0805 LED package
- InGaN technology
- Viewing angle: 140 deg typ.

Description:

These ultra bright 0805 LEDs have a height profile of 0.8mm. Combination of high brightness output and small footprint, these LEDs are ideal for keypad backlighting and status indication.

Application:

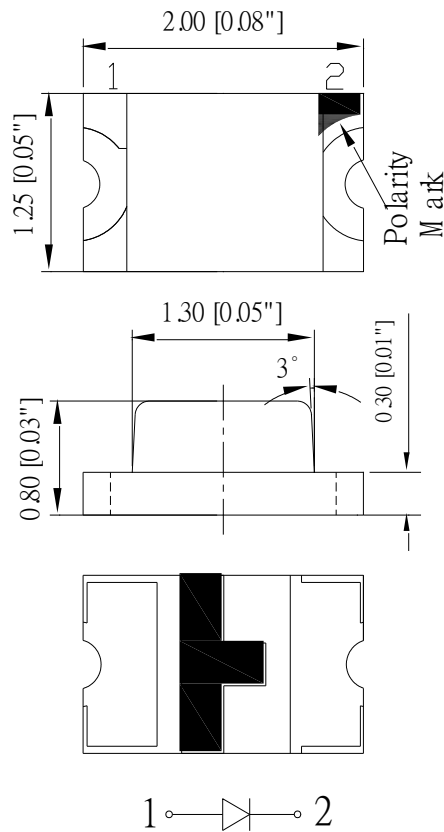
- Status indication
- Back lighting application

Certification & Compliance:

- ISO9001
- RoHS Compliant



Dimension:



Units: mm / tolerance = +/-0.1mm

Electrical / Optical Characteristic (Ta=25 °C)

Product	Color	I _F (mA)	V _F (V)		λ _D (nm)			λ _P (nm)	I _V (mcd)	
			Typ.	Max.	Min.	Typ.	Max.	Typ.	Min.	Typ.
QBLP631-IG5-2897	Green	5	2.4	2.8	525	530	535	525	250	450

Absolute Maximum Rating

Material	P _d (mW)	I _F (mA)	I _{FP} (mA)*	V _R (V)	T _{OP} (°C)	T _{ST} (°C)	T _{SO L} (°C)**
InGaN	84	30	125	5	-40 ~ +80	-40 ~ +85	260

*Duty 1/8 @ 1KHz

**IR Reflow for no more than 10 sec @ 260 °C

Forward Voltage V_F @ I_F=5mA

Bin	Min.	Max.	Unit
c	1.9	2.2	V
d	2.2	2.5	
e	2.5	2.8	

Luminous Intensity I_V @ I_F=5mA

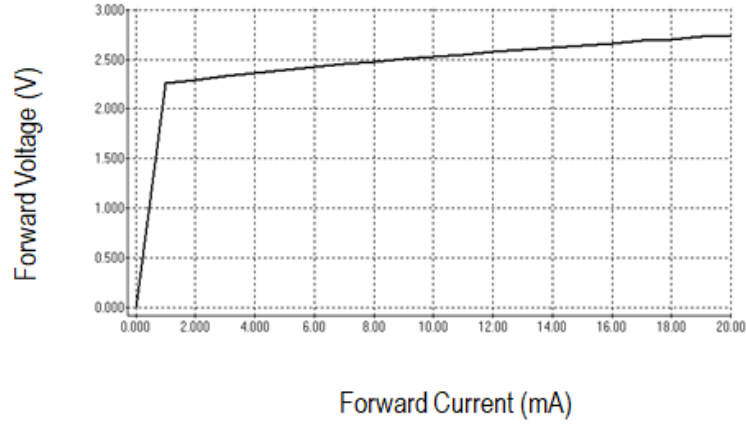
Bin	Min.	Max.	Unit
N	250	320	mcd
O	320	400	
P	400	500	
Q	500	630	
R	630	800	

Dominant Wavelength λ_D @ I_F=5mA

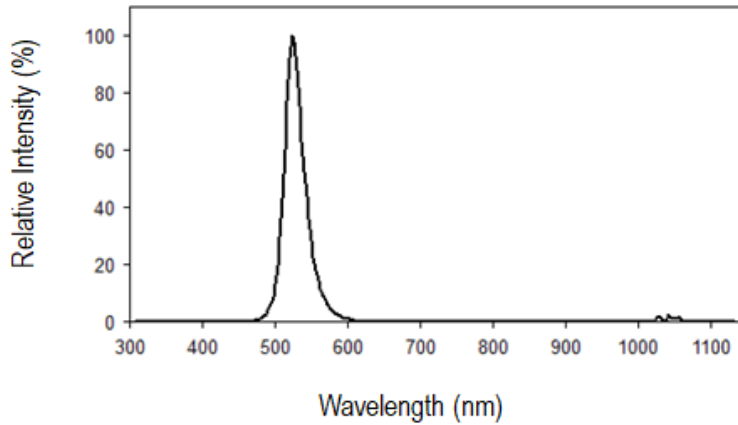
Bin	Min.	Max.	Unit
W	525	527.5	nm
X	527.5	530	
Y	530	532.5	
Z	532.5	535	

Characteristic Curves

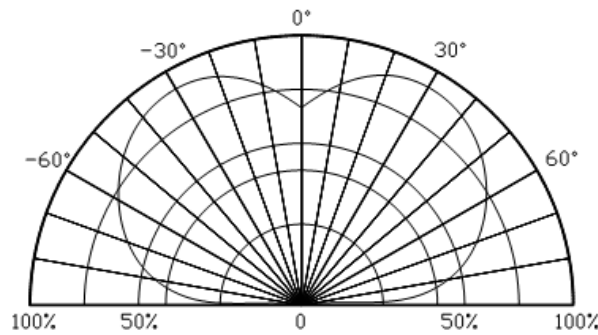
Forward Current vs. Forward Voltage



Relative Intensity vs. Wavelength

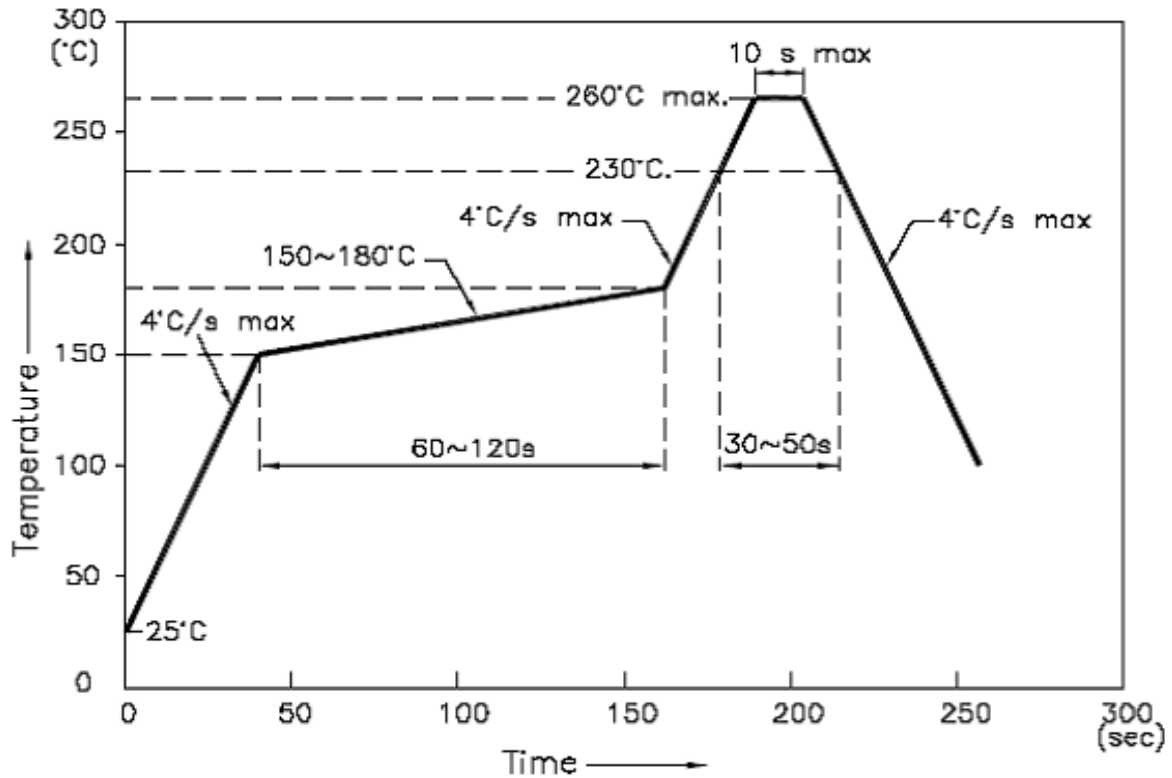


Directive Characteristics

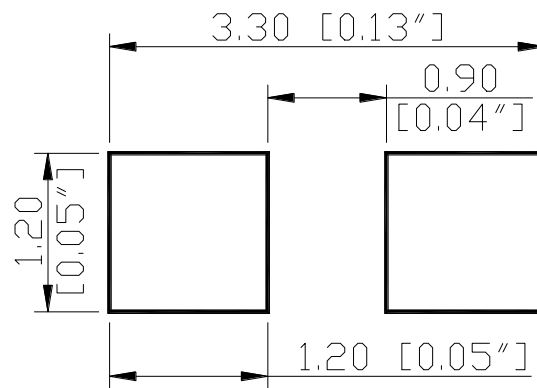


Solder Profile & Footprint

-The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



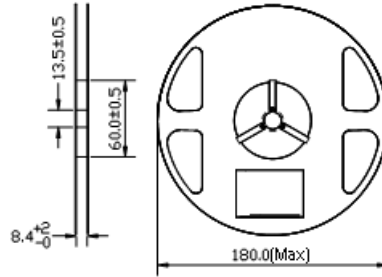
Recommended Pad Layout



Units: mm

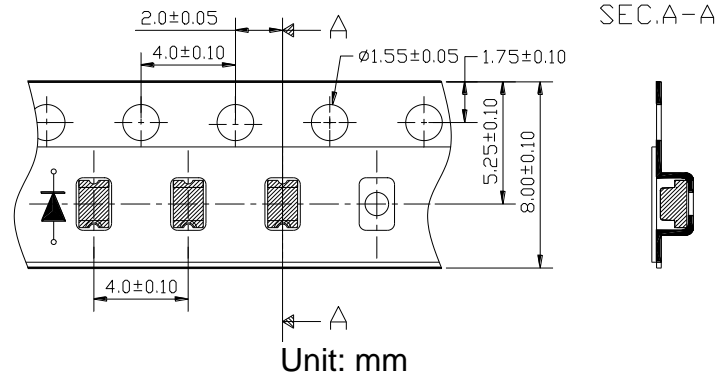
Packing

Reel Dimension:



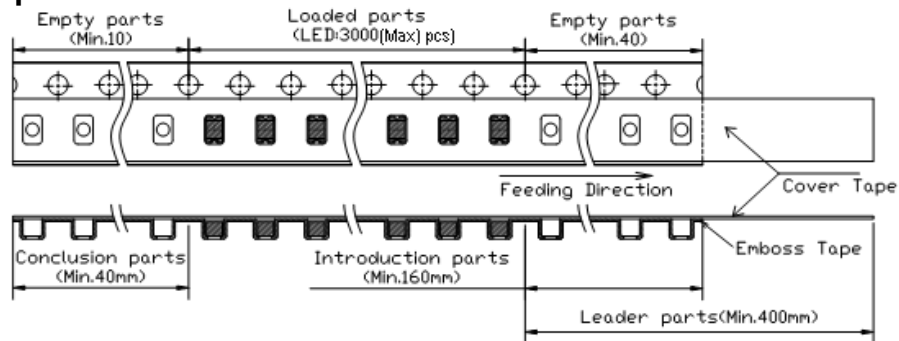
Unit: mm

Tape Dimension:

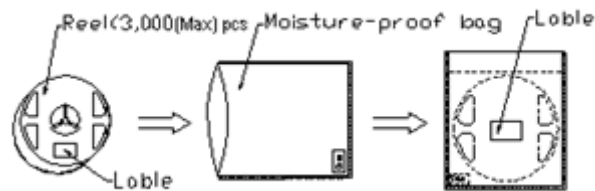


Unit: mm

Arrangement of Tape:



Packaging Specification:



Labeling

Part No: _____
 Customer P/N: _____
 Item: _____
 Q'ty: _____
 Vf: _____
 Iv: _____
 Wl: _____
 Date: _____

Made in China**Ordering Information**

Orderable Part #	Spec Range	Quantity per reel
QBLP631-IG5-2897	Iv=450mcd typ. / $\lambda_D = 525\text{nm to } 535\text{nm @ } 5\text{mA}$	3000 units

Product: QBLP631-IG5-2897	Date: March 27, 2024	Page 8 of 9
	Version# 1.0	

Revision History

Description:	Revision #	Revision Date
New Release of QBLP631-IG5-2897	V1.0	03/27/2024



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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.